

NE/SA5204 Wide-band High-Frequency Amplifier

Product Specification

Linear Products

DESCRIPTION

The NE/SA5204 is a high-frequency amplifier with a fixed insertion gain of 20dB. The gain is flat to ± 0.5 dB from DC to 200MHz. The -3dB bandwidth is greater than 350MHz. This performance makes the amplifier ideal for cable TV applications. The NE/SA5204 operates with a single supply of 6V, and only draws 25mA of supply current, which is much less than comparable hybrid parts. The noise figure is 4.8dB in a 75 Ω system and 6dB in a 50 Ω system.

The NE/SA5204 is a relaxed version of the NE5205. Minimum guaranteed bandwidth is relaxed to 350MHz and the "S" parameter Min/Max limits are specified as typical only.

Until now, most RF or high-frequency designers had to settle for discrete or hybrid solutions to their amplification problems. Most of these solutions required trade-offs that the designer had to accept in order to use high-frequency gain stages. These include high power consumption, large component count, transformers, large packages with heat sinks, and high part cost. The NE/SA5204 solves these problems by incorporating a wideband amplifier on a single monolithic chip.

The part is well matched to 50 or 75 Ω input and output impedances. The standing wave ratios in 50 and 75 Ω systems do not exceed 1.5 on either the input or output over the entire DC to 350MHz operating range.

Since the part is a small, monolithic IC die, problems such as stray capacitance are minimized. The die size is small enough to fit into a very cost-effective 8-pin small-outline (SO) package to further reduce parasitic effects.

ORDERING INFORMATION

| DESCRIPTION | TEMPERATURE RANGE | ORDER CODE |
|--------------------------|-------------------|------------|
| 8-Pin Plastic DIP | 0 to +70°C | NE5204N |
| | -40 to +85°C | SA5204N |
| 8-Pin Plastic SO package | 0 to +70°C | NE5204D |
| | -40 to +85°C | SA5204D |

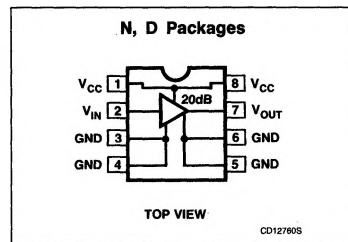
No external components are needed other than AC-coupling capacitors because the NE/SA5204 is internally compensated and matched to 50 and 75 Ω . The amplifier has very good distortion specifications, with second and third-order intermodulation intercepts of +24dBm and +17dBm, respectively, at 100MHz.

The part is well matched for 50 Ω test equipment such as signal generators, oscilloscopes, frequency counters, and all kinds of signal analyzers. Other applications at 50 Ω include mobile radio, CB radio, and data/video transmission in fiber optics, as well as broadband LANs and telecom systems. A gain greater than 20dB can be achieved by cascading additional NE/SA5204s in series as required, without any degradation in amplifier stability.

FEATURES

- 200MHz (min.), ± 0.5 dB bandwidth
- 20dB insertion gain
- 4.8dB (6dB) noise figure
 $Z_0 = 75\Omega$ ($Z_0 = 50\Omega$)
- No external components required
- Input and output impedances matched to 50/75 Ω systems
- Surface-mount package available
- Cascadable

PIN CONFIGURATION



APPLICATIONS

- Antenna amplifiers
- Amplified splitters
- Signal generators
- Frequency counters
- Oscilloscopes
- Signal analyzers
- Broadband LANs
- Networks
- Modems
- Mobile radio
- CB radio
- Telecommunications

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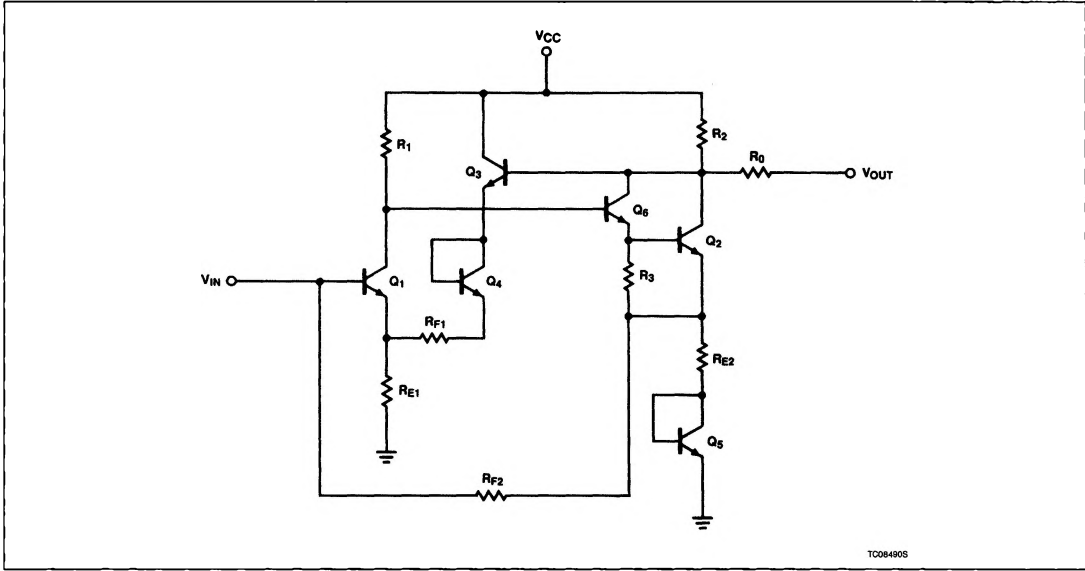
ABSOLUTE MAXIMUM RATINGS

| SYMBOL | PARAMETER | RATING | UNIT |
|-------------------|--|------------------------|------------------|
| V _{CC} | Supply voltage | 9 | V |
| V _{IN} | AC input voltage | 5 | V _{P,P} |
| T _A | Operating ambient temperature range NE grade SA grade | 0 to +70 -40 to +85 | °C °C |
| P _D | Maximum power dissipation ^{1, 2} T _A = 25°C (still-air) N package D package | 1160 780 | mW mW |
| T _J | Junction temperature | 150 | °C |
| T _{STG} | Storage temperature range | -55 to +150 | °C |
| T _{SOLD} | Lead temperature (soldering 60s) | 300 | °C |

NOTES:

- 1. Derate above 25°C, at the following rates
N package at 9.3mW/°C
D package at 6.2mW/°C.
- 2. See "Power Dissipation Considerations" section.

EQUIVALENT SCHEMATIC

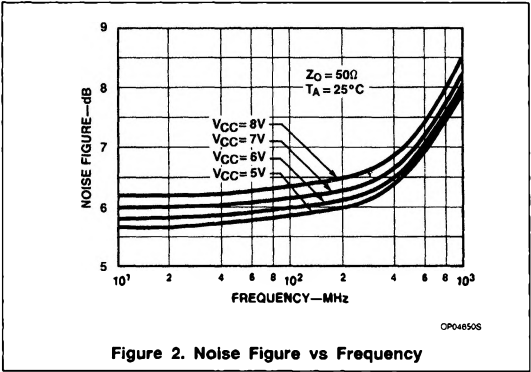
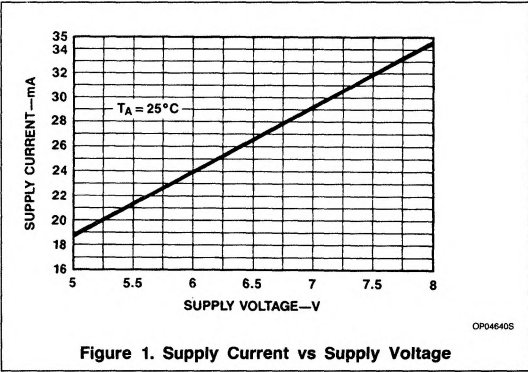


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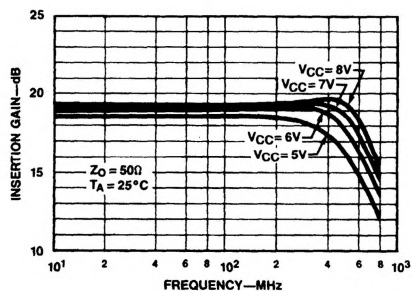
DC ELECTRICAL CHARACTERISTICS at $V_{CC} = 6V$, $Z_S = Z_L = Z_O = 50\Omega$ and $T_A = 25^\circ C$, in all packages, unless otherwise specified.

| SYMBOL | PARAMETER | TEST CONDITIONS | LIMITS | | | UNIT |
|----------|---|---------------------------------|--------|------|-----|------|
| | | | Min | Typ | Max | |
| V_{CC} | Operating supply voltage range | Over temperature | 5 | | 8 | V |
| I_{CC} | Supply current | Over temperature | 19 | 24 | 31 | mA |
| S21 | Insertion gain | $f = 100MHz$, over temperature | 16 | 19 | 22 | dB |
| S11 | Input return loss | $f = 100MHz$ | | 25 | | dB |
| | | DC – 550MHz | | 12 | | dB |
| S22 | Output return loss | $f = 100MHz$ | | 27 | | dB |
| | | DC – 550MHz | | 12 | | dB |
| S12 | Isolation | $f = 100MHz$ | | –25 | | dB |
| | | DC – 550MHz | | –18 | | dB |
| BW | Bandwidth | $\pm 0.5dB$ | 200 | 350 | | MHz |
| BW | Bandwidth | –3dB | 350 | 550 | | MHz |
| | Noise figure (75 Ω) | $f = 100MHz$ | | 4.8 | | dB |
| | Noise figure (50 Ω) | $f = 100MHz$ | | 6.0 | | dB |
| | Saturated output power | $f = 100MHz$ | | +7.0 | | dBm |
| | 1dB gain compression | $f = 100MHz$ | | +4.0 | | dBm |
| | Third-order intermodulation intercept (output) | $f = 100MHz$ | | +17 | | dBm |
| | Second-order intermodulation intercept (output) | $f = 100MHz$ | | +24 | | dBm |

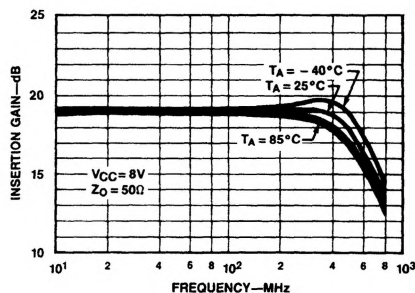


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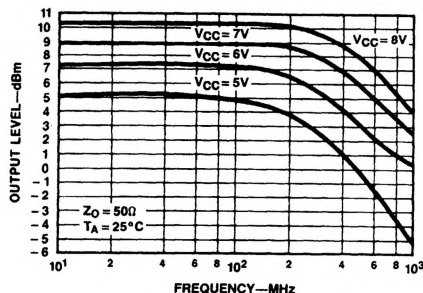
NE/SA5204



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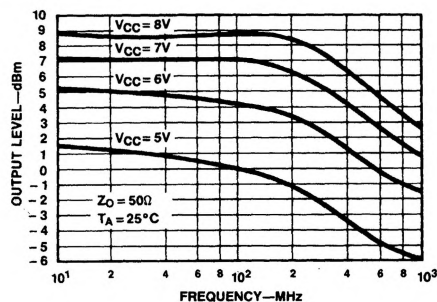
Figure 3. Insertion Gain vs Frequency (S_{21})

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Figure 4. Insertion Gain vs Frequency (S_{21})

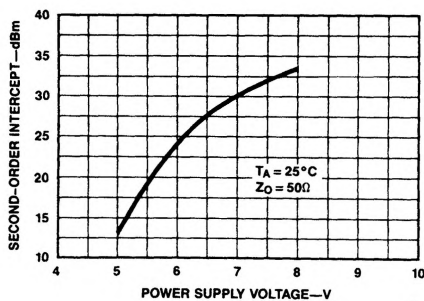
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Figure 5. Saturated Output Power vs Frequency



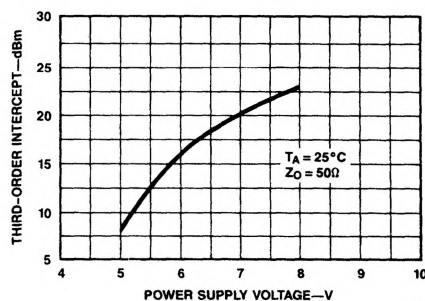
OP04690S

Figure 6. 1dB Gain Compression vs Frequency



OP04700S

Figure 7. Second-Order Output Intercept vs Supply Voltage



OP04710S

Figure 8. Third-Order Intercept vs Supply Voltage

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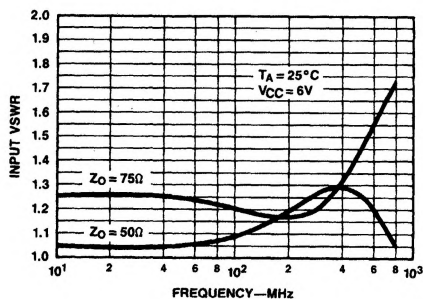


Figure 9. Input VSWR vs Frequency

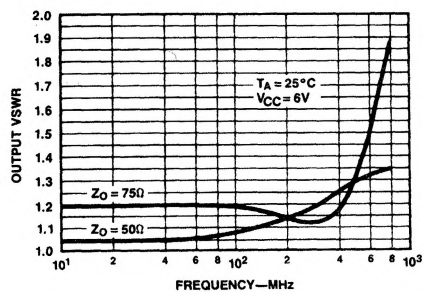
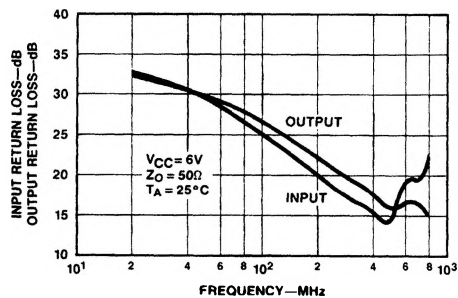
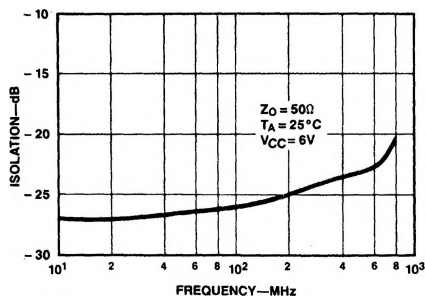
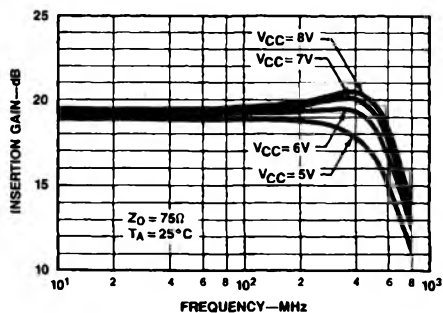
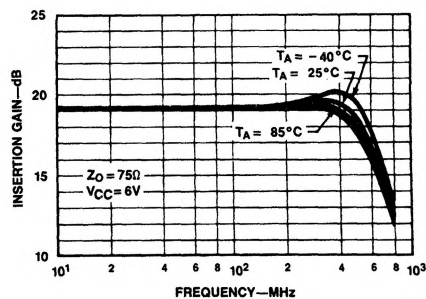


Figure 10. Output VSWR vs Frequency

Figure 11. Input (S_{11}) and Output (S_{22}) Return Loss vs FrequencyFigure 12. Isolation vs Frequency (S_{12})Figure 13. Insertion Gain vs Frequency (S_{21})Figure 14. Insertion Gain vs Frequency (S_{21})

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THEORY OF OPERATION

The design is based on the use of multiple feedback loops to provide wide-band gain together with good noise figure and terminal impedance matches. Referring to the circuit schematic in Figure 15, the gain is set primarily by the equation:

$$\frac{V_{OUT}}{V_{IN}} = (R_{F1} + R_{E1}) / R_{E1} \quad (1)$$

which is series-shunt feedback. There is also shunt-series feedback due to R_{F2} and R_{E2} which aids in producing wide-band terminal impedances without the need for low value input shunting resistors that would degrade the noise figure. For optimum noise performance, R_{E1} and the base resistance of Q_1 are kept as low as possible, while R_{F2} is maximized.

The noise figure is given by the following equation:

$$NF = 10 \log \left\{ 1 + \frac{\left[r_b + R_{E1} + \frac{KT}{2qI_{C1}} \right]}{R_0} \right\} \text{ dB} \quad (2)$$

where $I_{C1} = 5.5 \text{ mA}$, $R_{E1} = 12 \Omega$, $r_b = 130 \Omega$, $KT/q = 26 \text{ mV}$ at 25°C and $R_0 = 50$ for a 50Ω system and 75 for a 75Ω system.

The DC input voltage level V_{IN} can be determined by the equation:

$$V_{IN} = V_{BE1} + (I_{C1} + I_{C3}) R_{E1} \quad (3)$$

where $R_{E1} = 12 \Omega$, $V_{BE} = 0.8 \text{ V}$, $I_{C1} = 5 \text{ mA}$ and $I_{C3} = 7 \text{ mA}$ (currents rated at $V_{CC} = 6 \text{ V}$).

Under the above conditions, V_{IN} is approximately equal to 1 V .

Level shifting is achieved by emitter-follower Q_3 and diode Q_4 , which provide shunt feedback to the emitter of Q_1 via R_{F1} . The use of an emitter-follower buffer in this feedback loop essentially eliminates problems of shunt-feedback loading on the output. The value of $R_{F1} = 140 \Omega$ is chosen to give the desired nominal gain. The DC output voltage V_{OUT} can be determined by:

$$V_{OUT} = V_{CC} - (I_{C2} + I_{C6}) R_2 \quad (4)$$

where $V_{CC} = 6 \text{ V}$, $R_2 = 225 \Omega$, $I_{C2} = 7 \text{ mA}$ and $I_{C6} = 5 \text{ mA}$.

From here, it can be seen that the output voltage is approximately 3.3 V to give relatively equal positive and negative output swings. Diode Q_5 is included for bias purposes to allow direct coupling of R_{F2} to the base of Q_1 . The dual feedback loops stabilize the DC operating point of the amplifier.

The output stage is a Darlington pair (Q_6 and Q_2) which increases the DC bias voltage on the input stage (Q_1) to a more desirable value, and also increases the feedback loop gain. Resistor R_0 optimizes the output VSWR (Voltage Standing Wave Ratio). Inductors L_1 and L_2 are bondwire and lead inductances which are roughly 3 nH . These improve the high-frequency impedance matches at input and output by partially resonating with 0.5 pF of pad and package capacitance.

POWER DISSIPATION CONSIDERATIONS

When using the part at elevated temperature, the engineer should consider the power dissipation capabilities of each package.

At the nominal supply voltage of 6 V , the typical supply current is 25 mA (30 mA max). For operation at supply voltages other than 6 V , see Figure 1 for I_{CC} versus V_{CC} curves. The supply current is inversely proportional to temperature and varies no more than 1 mA between 25°C and either temperature extreme. The change is 0.1% per $^\circ\text{C}$ over the range.

The recommended operating temperature ranges are air-mount specifications. Better heat-sinking benefits can be realized by mounting the SO and N package bodies against the PC board plane.

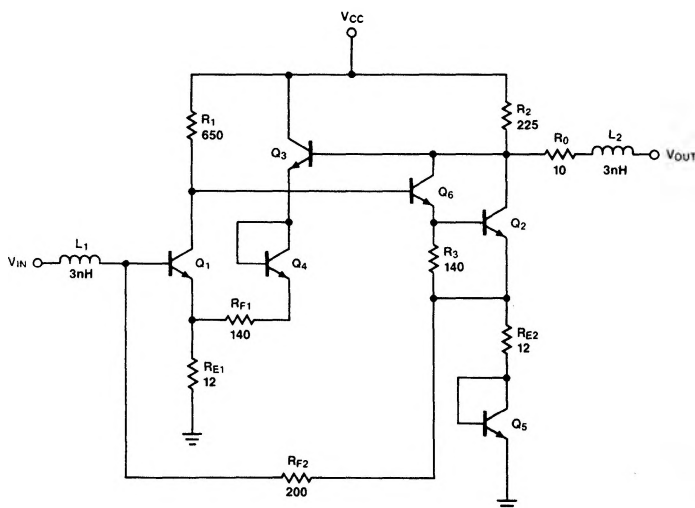


Figure 15. Schematic Diagram

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PC BOARD MOUNTING

In order to realize satisfactory mounting of the NE5204 to a PC board, certain techniques need to be utilized. The board must be double-sided with copper and all pins must be soldered to their respective areas (i.e., all GND and V_{CC} pins on the package). The power supply should be decoupled with a capacitor as close to the V_{CC} pins as possible, and an RF choke should be inserted between the supply and the device. Caution should be exercised in the connection of input and output pins. Standard microstrip should be observed wherever possible. There should be no solder bumps or burrs or any obstructions in the signal path to cause launching problems. The path should be as straight as possible and lead lengths as short as possible from the part to the cable connection. Another important consideration is that the input and output should be AC-coupled. This is because at $V_{CC} = 6V$, the input is approximately at 1V while the output is at 3.3V. The output must be decoupled into a low-impedance system, or the DC bias on the output of the amplifier will be loaded down, causing loss of output power. The easiest way to decouple the entire amplifier is by soldering a high-frequency chip capacitor directly to the input and output pins of the device. This circuit is shown in Figure 16. Follow these recommendations to get the best frequency response and noise immunity. The board design is as important as the integrated circuit design itself.

Both of the evaluation boards that will be discussed next do not have input and output capacitors because it is assumed the user will use AC-coupled test systems. Chip or foil capacitors can easily be inserted between the part and connector if the board trace is removed.

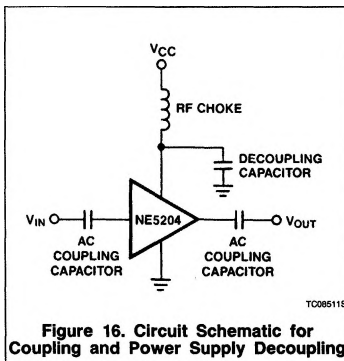


Figure 16. Circuit Schematic for Coupling and Power Supply Decoupling

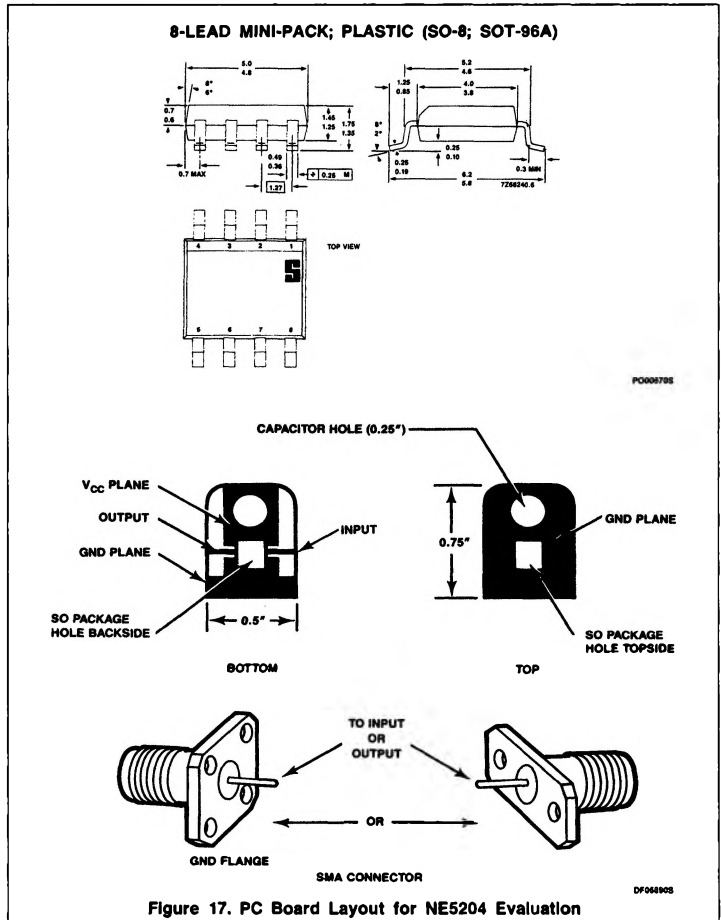


Figure 17. PC Board Layout for NE5204 Evaluation

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50 Ω EVALUATION BOARD

The evaluation board layout shown in Figure 17 produces excellent results. The board is to scale and is for the SO package. Both top and bottom are copper clad and the ground planes are bonded together through 50 Ω SMA cable connectors. These are solder mounted on the sides of the board so that the signal traces line up straight to the connector signal pins.

Solid copper tubing is soldered through the flange holes between the two connectors for increased strength and grounding characteristics. Two- or four-hole flanges can be used. A flat, round decoupling capacitor is placed in the board's round hole and soldered between the bottom V_{CC} plane and the top side ground. The capacitor is as thin or thinner than the PC board thickness and has insula-

tion around its side to isolate V_{CC} and ground. The square hole is for the SO package which is put in upside-down through the bottom of the board so that the leads are kept in position for soldering. Both holes are just slightly larger than the capacitor and IC to provide for a tight fit.

This board should be tested in a system with 50 Ω input and output impedance for correct operation.

excellent way to test the part for cable TV applications. Again, the board should be tested in a system with 75 Ω input- and output-impedance for correct operation.

NOTE:

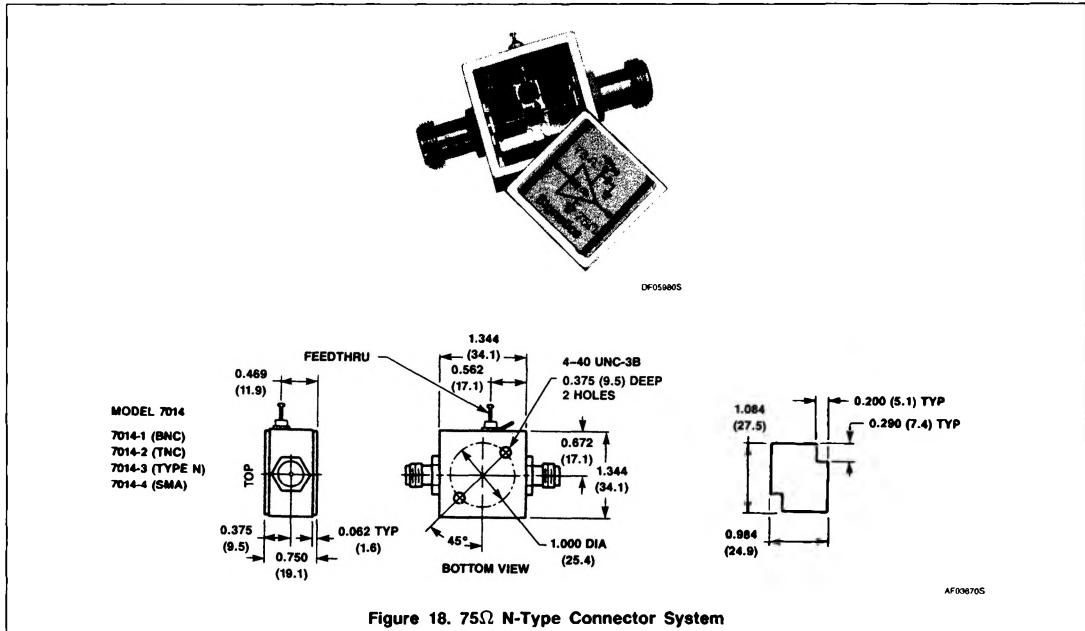
*The box and connectors are available as a "MOD-PACK SYSTEM" from the ANZAC division of ADAMS-RUSSELL CO., INC., 80 Cambridge Street, Burlington, MA 01803.

75 Ω EVALUATION BOARD

Another evaluation board is shown in Figure 18. This system uses the same PC board as presented in Figure 17, but makes use of 75 Ω female N-type connectors. The board is mounted in a nickel plated box* that is used to support the N-type connectors. This is an

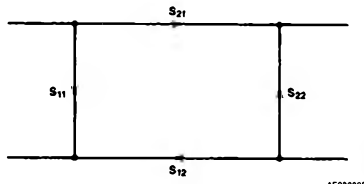
SCATTERING PARAMETERS

The primary specifications for the NE5204 are listed as S-parameters. S-parameters are measurements of incident and reflected currents and voltages between the source, amplifier, and load as well as transmission losses. The parameters for a two-port network are defined in Figure 19.



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AF036805

a. Two-Port Network Defined

 S_{11} — INPUT RETURN LOSS

$$S_{11} = \sqrt{\frac{\text{POWER REFLECTED FROM INPUT PORT}}{\text{POWER AVAILABLE FROM GENERATOR AT INPUT PORT}}}$$

 S_{12} — REVERSE TRANSMISSION LOSS OR ISOLATION

$$S_{12} = \sqrt{\frac{\text{REVERSE TRANSDUCER POWER GAIN}}{\text{POWER AVAILABLE FROM GENERATOR AT OUTPUT PORT}}}$$

 S_{21} — FORWARD TRANSMISSION LOSS OR INSERTION GAIN

$$S_{21} = \sqrt{\frac{\text{TRANSDUCER POWER GAIN}}{\text{POWER REFLECTED FROM OUTPUT PORT}}}$$

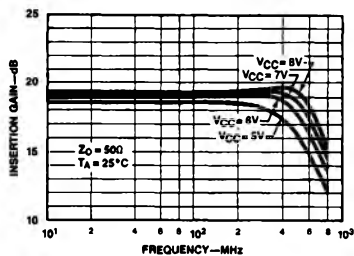
 S_{22} — OUTPUT RETURN LOSS

$$S_{22} = \sqrt{\frac{\text{POWER REFLECTED FROM OUTPUT PORT}}{\text{POWER AVAILABLE FROM GENERATOR AT OUTPUT PORT}}}$$

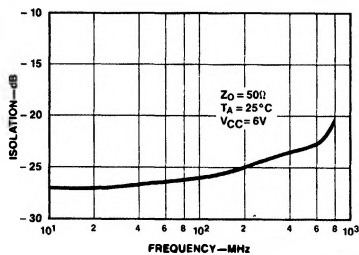
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b.

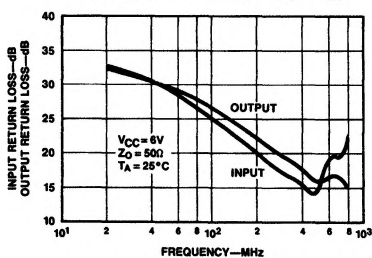
Figure 19

50 Ω System

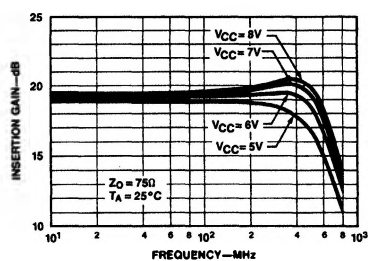
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a. Insertion Gain vs Frequency (S_{21})

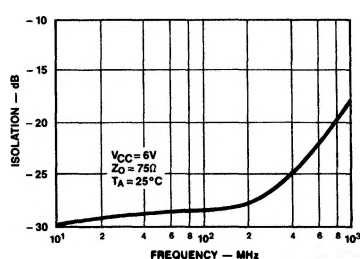
OP048005

c. Isolation vs Frequency (S_{12})

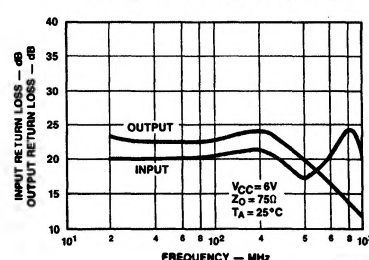
OP048205

e. Input (S_{11}) and Output (S_{22}) Return Loss vs Frequency75 Ω System

OP047905

b. Insertion Gain vs Frequency (S_{21})

OP048105

d. S_{12} Isolation vs Frequency

OP048305

f. Input (S_{11}) and Output (S_{22}) Return Loss vs Frequency

Figure 20

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Actual S-parameter measurements, using an HP network analyzer (model 8505A) and an HP S-parameter tester (models 8503A/B), are shown in Figure 20. These were obtained with the device mounted in a PC board as described in Figures 17 and 18.

For 50Ω system measurements, SMA connectors were used. The 75Ω data was obtained using N-connectors.

Values for Figure 20 are measured and specified in the data sheet to ease adaptation and comparison of the NE5204 to other high-frequency amplifiers. The most important parameter is S_{21} . It is defined as the square root of the power gain, and, in decibels, is equal to voltage gain as shown below:

$$Z_D = Z_{IN} = Z_{OUT} \text{ for the NE5204}$$

$$P_{IN} = \frac{V_{IN}^2}{Z_D} \quad \text{NE5204} \quad P_{OUT} = \frac{V_{OUT}^2}{Z_D}$$

$$\therefore \frac{P_{OUT}}{P_{IN}} = \frac{\frac{V_{OUT}^2}{Z_D}}{\frac{V_{IN}^2}{Z_D}} = \frac{V_{OUT}^2}{V_{IN}^2} = P_I$$

$$P_I = V_I^2$$

P_I = Insertion Power Gain
 V_I = Insertion Voltage Gain

Measured value for the NE5204 = $|S_{21}|^2 = 100$

$$\therefore P_I = \frac{P_{OUT}}{P_{IN}} = |S_{21}|^2 = 100$$

$$\text{and } V_I = \frac{V_{OUT}}{V_{IN}} = \sqrt{P_I} = S_{21} = 10$$

In decibels:

$$P_{I(dB)} = 10 \log |S_{21}|^2 = 20 \text{ dB}$$

$$V_{I(dB)} = 20 \log S_{21} = 20 \text{ dB}$$

$$\therefore P_{I(dB)} = V_{I(dB)} = S_{21(dB)} = 20 \text{ dB}$$

Also measured on the same system are the respective voltage standing-wave ratios. These are shown in Figure 21. The VSWR can be seen to be below 1.5 across the entire operational frequency range.

Relationships exist between the input and output return losses and the voltage standing wave ratios. These relationships are as follows:

$$\text{INPUT RETURN LOSS} = S_{11(dB)}$$

$$S_{11(dB)} = 20 \log |S_{11}|$$

$$\text{OUTPUT RETURN LOSS} = S_{22(dB)}$$

$$S_{22(dB)} = 20 \log |S_{22}|$$

$$\text{INPUT VSWR} = \frac{1 + |S_{11}|}{1 - |S_{11}|} \leq 1.5$$

$$\text{OUTPUT VSWR} = \frac{1 + |S_{22}|}{1 - |S_{22}|} \leq 1.5$$

1dB GAIN COMPRESSION AND SATURATED OUTPUT POWER

The 1dB gain compression is a measurement of the output power level where the small-signal insertion gain magnitude decreases 1dB from its low power value. The decrease is due to non-linearities in the amplifier, an indication of the point of transition between small-signal operation and the large-signal mode.

The saturated output power is a measure of the amplifier's ability to deliver power into an external load. It is the value of the amplifier's output power when the input is heavily over-driven. This includes the sum of the power in all harmonics.

INTERMODULATION INTERCEPT TESTS

The intermodulation intercept is an expression of the low level linearity of the amplifier. The intermodulation ratio is the difference in dB between the fundamental output signal level and the generated distortion product level. The relationship between intercept and intermodulation ratio is illustrated in Figure 22, which shows product output levels plotted versus the level of the fundamental output for two equal strength output signals at different frequencies. The upper line shows the fundamental output plotted against itself with a 1dB to 1dB slope. The second and third order products lie below the fundamentals and exhibit a 2:1 and 3:1 slope, respectively.

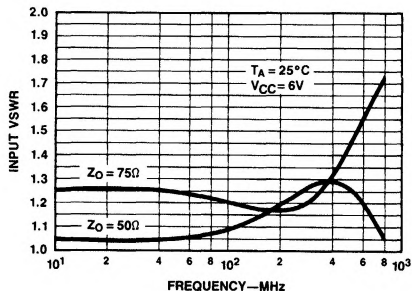
The intercept point for either product is the intersection of the extensions of the product curve with the fundamental output.

The intercept point is determined by measuring the intermodulation ratio at a single output level and projecting along the appropriate product slope to the point of intersection with the fundamental. When the intercept point is known, the intermodulation ratio can be determined by the reverse process. The second-order IMR is equal to the difference between the second-order intercept and the fundamental output level. The third-order IMR is equal to twice the difference between the third-order intercept and the fundamental output level. These are expressed as:

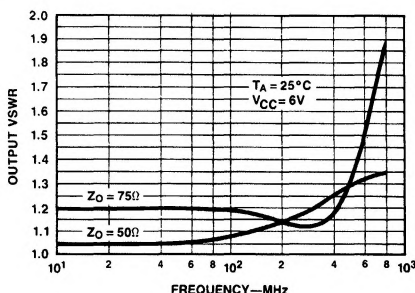
$$IP_2 = P_{OUT} + IMR_2$$

$$IP_3 = P_{OUT} + IMR_3/2$$

where P_{OUT} is the power level in dBm of each of a pair of equal level fundamental output signals, IP_2 and IP_3 are the second- and third-order output intercepts in dBm, and IMR_2 and IMR_3 are the second- and third-order intermodulation ratios in dB. The intermodulation intercept is an indicator of intermodulation performance only in the small-signal operat-



a. Input VSWR vs Frequency



b. Output VSWR vs Frequency

Figure 21. Input/Output VSWR vs Frequency

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ing range of the amplifier. Above some output level which is below the 1dB compression point, the active device moves into large-signal operation. At this point, the intermodulation products no longer follow the straight-line output slopes, and the intercept description is no longer valid. It is therefore important to measure IP_2 and IP_3 at output levels well below 1dB compression. One must be careful, however, not to select levels which are too low, because the test equipment may not be able to recover the signal from the noise. For the NE5204, an output level of -10.5dBm was chosen with fundamental frequencies of 100.000 and 100.01MHz, respectively.

ADDITIONAL READING ON SCATTERING PARAMETERS

For more information regarding S-parameters, please refer to *High-Frequency Amplifiers*; by Ralph S. Carson of the University of Missouri, Rolla, Copyright 1985, published by John Wiley & Sons, Inc.

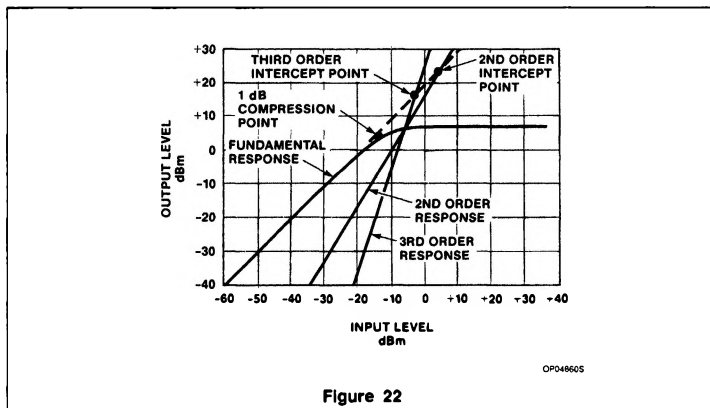


Figure 22

S-Parameter Techniques for Faster, More Accurate Network Design, HP App Note 95-1, Richard W. Anderson, 1967, HP Journal.

S-Parameter Design, HP App Note 154, 1972.